



**THE DATASHEET OF
PBSS4041NZ,115**





PBSS4041NZ

60 V, 7 A NPN low V_{CEsat} (BISS) transistor

Rev. 2 — 8 August 2012

Product data sheet

1. Product profile

1.1 General description

NPN low V_{CEsat} Breakthrough In Small Signal (BISS) transistor in a SOT223 (SC-73) medium power Surface-Mounted Device (SMD) plastic package.

PNP complement: PBSS4041PZ.

1.2 Features and benefits

- Very low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High collector current gain (h_{FE}) at high I_C
- High energy efficiency due to less heat generation
- AEC-Q101 qualified
- Smaller required PCB area than for conventional transistors

1.3 Applications

- Loadswitch
- Battery-driven devices
- Power management
- Charging circuits
- Power switches (e.g. motors, fans)

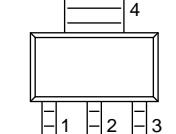
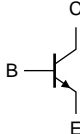
1.4 Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------|---|---|-----|------|-----|------------|
| V_{CEO} | collector-emitter voltage | open base | - | - | 60 | V |
| I_C | collector current | | - | - | 7 | A |
| I_{CM} | peak collector current | single pulse; $t_p \leq 1$ ms | - | - | 15 | A |
| R_{CEsat} | collector-emitter saturation resistance | $I_C = 6$ A; $I_B = 600$ mA; pulsed; $t_p \leq 300$ μ s; $\delta \leq 0.02$; $T_{amb} = 25$ °C | - | 17.5 | 25 | m Ω |

2. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|---|---|
| 1 | B | base |  <p>SOT223 (SC-73)</p> |  <p>sym123</p> |
| 2 | C | collector | | |
| 3 | E | emitter | | |
| 4 | C | collector | | |

3. Ordering information

Table 3. Ordering information

| Type number | Package | | |
|-------------|---------|---|---------|
| | Name | Description | Version |
| PBSS4041NZ | SC-73 | plastic surface-mounted package with increased heatsink; 4 leads | SOT223 |

4. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PBSS4041NZ | PB4041NZ |

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|---------------------------|-------------------------------|-----|------|------|
| V_{CBO} | collector-base voltage | open emitter | - | 60 | V |
| V_{CEO} | collector-emitter voltage | open base | - | 60 | V |
| V_{EBO} | emitter-base voltage | open collector | - | 5 | V |
| I_C | collector current | | - | 7 | A |
| I_{CM} | peak collector current | single pulse; $t_p \leq 1$ ms | - | 15 | A |
| I_B | base current | | - | 1 | A |
| P_{tot} | total power dissipation | $T_{amb} \leq 25$ °C | [1] | 770 | mW |
| | | | [2] | 1700 | mW |
| | | | [3] | 2600 | mW |

Table 5. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|----------------------|------------|-----|-----|------|
| T_j | junction temperature | | - | 150 | °C |
| T_{amb} | ambient temperature | | -55 | 150 | °C |
| T_{stg} | storage temperature | | -65 | 150 | °C |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm².

[3] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

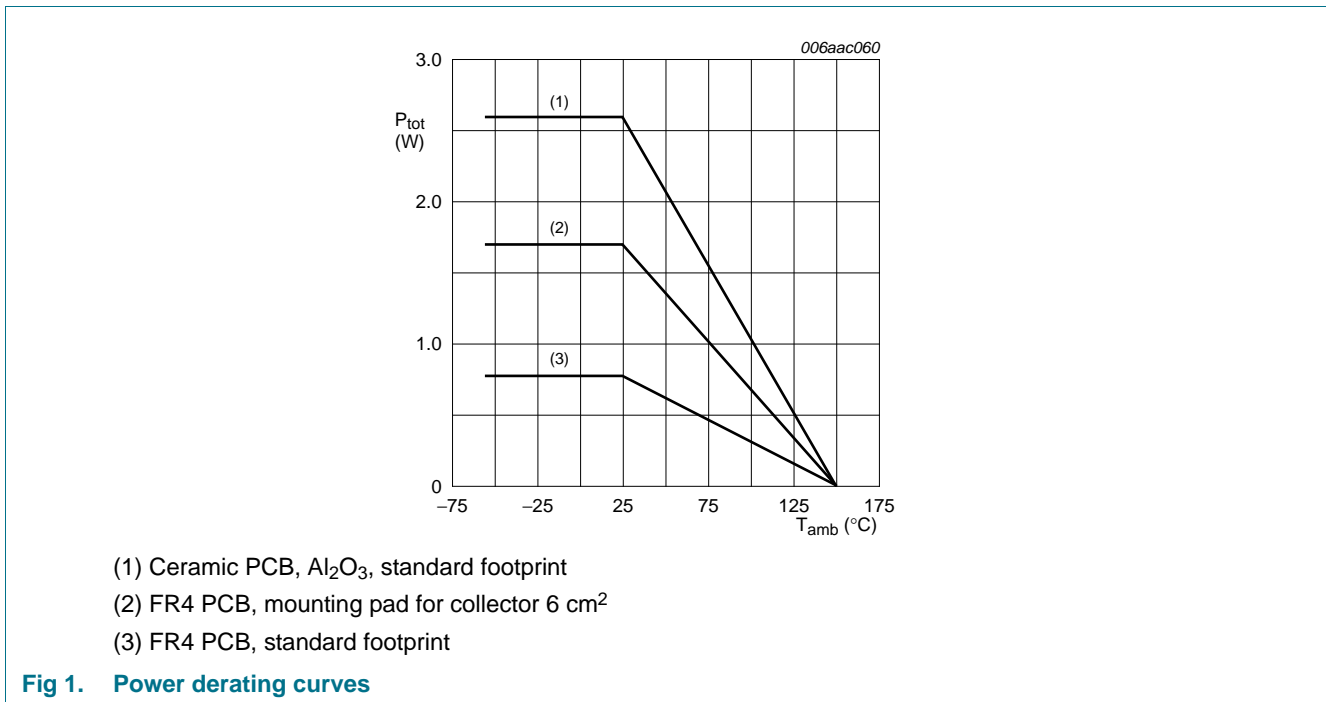


Fig 1. Power derating curves

6. Thermal characteristics

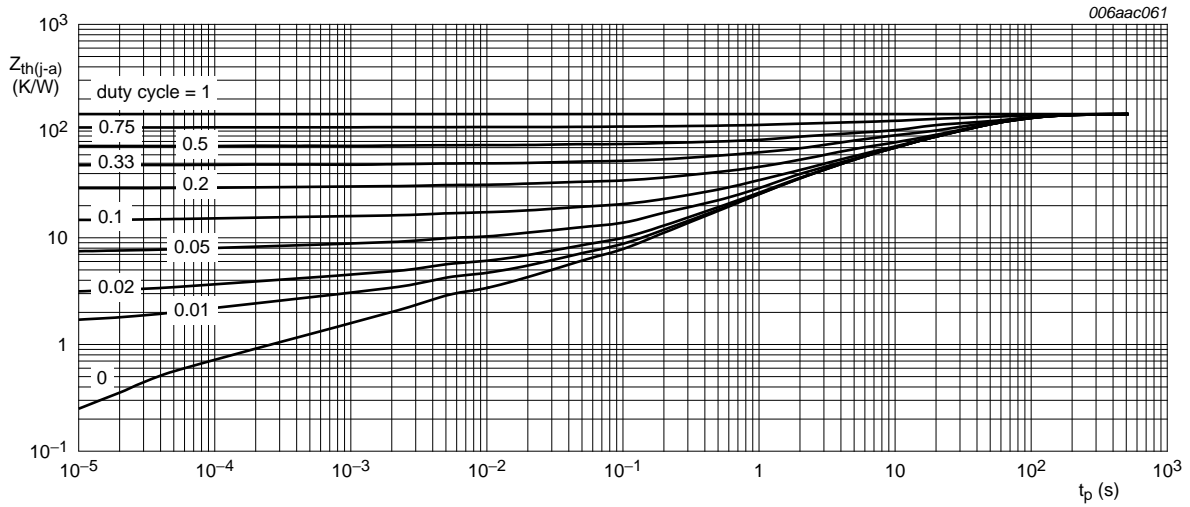
Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|----------------|--|------------|-----|-----|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | [1] | - | - | 160 | K/W |
| | | [2] | - | - | 75 | K/W |
| | | [3] | - | - | 50 | K/W |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point | | - | - | 11 | K/W |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

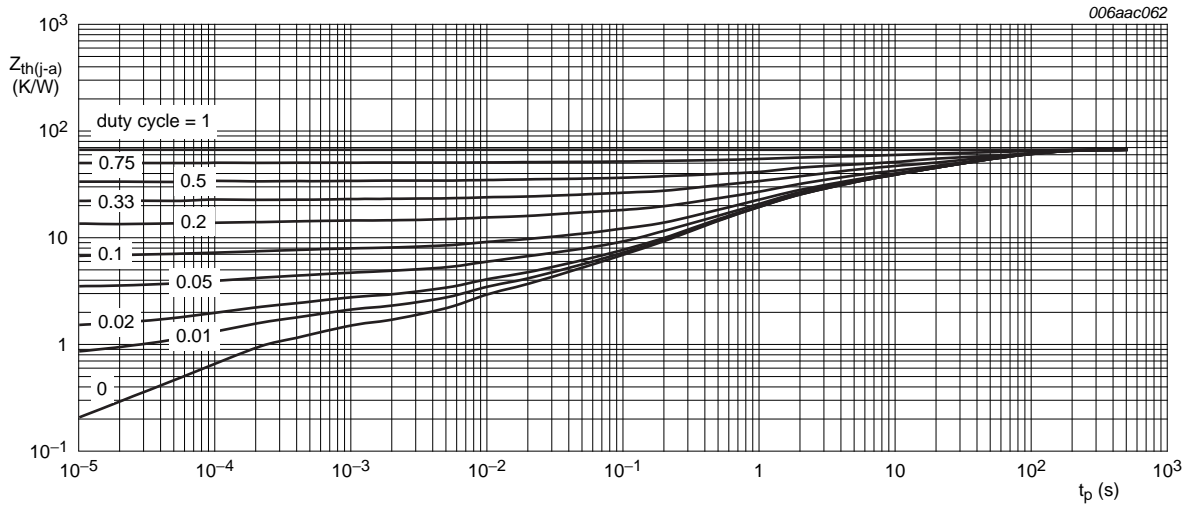
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm².

[3] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.



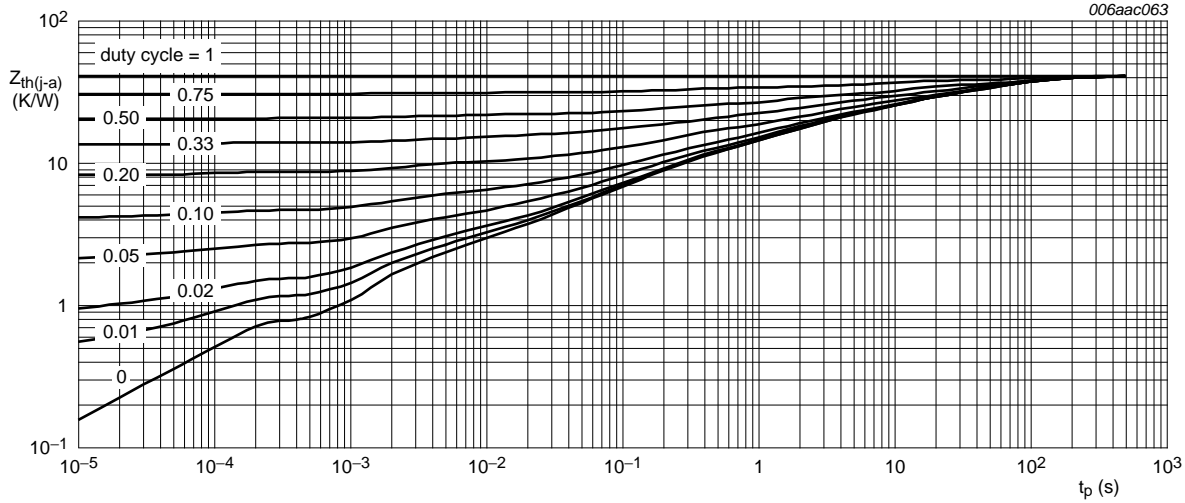
FR4 PCB, standard footprint

Fig 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for collector 6 cm²

Fig 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



Ceramic PCB, Al₂O₃, standard footprint

Fig 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

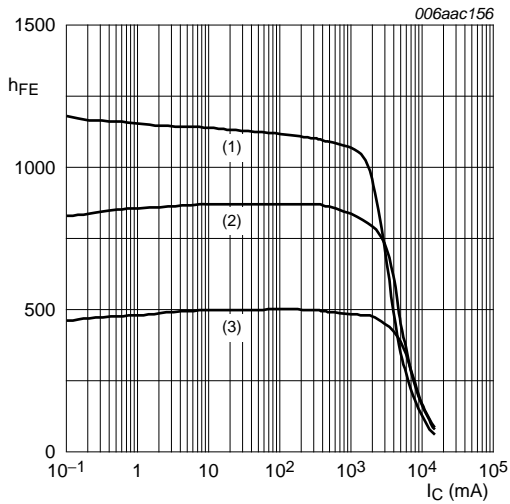
7. Characteristics

Table 7. Characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|------------------|-----------------------------------|---|-----|-----|-----|------|
| I _{CBO} | collector-base cut-off current | V _{CB} = 60 V; I _E = 0 A; T _{amb} = 25 °C | - | - | 100 | nA |
| | | V _{CB} = 60 V; I _E = 0 A; T _j = 150 °C | - | - | 50 | µA |
| I _{CES} | collector-emitter cut-off current | V _{CE} = 48 V; V _{BE} = 0 V; T _{amb} = 25 °C | - | - | 100 | nA |
| I _{EBO} | emitter-base cut-off current | V _{EB} = 5 V; I _C = 0 A; T _{amb} = 25 °C | - | - | 100 | nA |
| h _{FE} | DC current gain | V _{CE} = 2 V; I _C = 500 mA; pulsed; t _p ≤ 300 µs; δ ≤ 0.02; T _{amb} = 25 °C | 300 | 500 | - | |
| | | V _{CE} = 2 V; I _C = 1 A; pulsed; t _p ≤ 300 µs; δ ≤ 0.02; T _{amb} = 25 °C | 300 | 500 | - | |
| | | V _{CE} = 2 V; I _C = 2 A; pulsed; t _p ≤ 300 µs; δ ≤ 0.02; T _{amb} = 25 °C | 300 | 500 | - | |
| | | V _{CE} = 2 V; I _C = 4 A; pulsed; t _p ≤ 300 µs; δ ≤ 0.02; T _{amb} = 25 °C | 250 | 400 | - | |
| | | V _{CE} = 2 V; I _C = 6 A; pulsed; t _p ≤ 300 µs; δ ≤ 0.02; T _{amb} = 25 °C | 100 | 200 | - | |
| | | V _{CE} = 2 V; I _C = 7 A; pulsed; t _p ≤ 300 µs; δ ≤ 0.02; T _{amb} = 25 °C | 50 | 100 | - | |

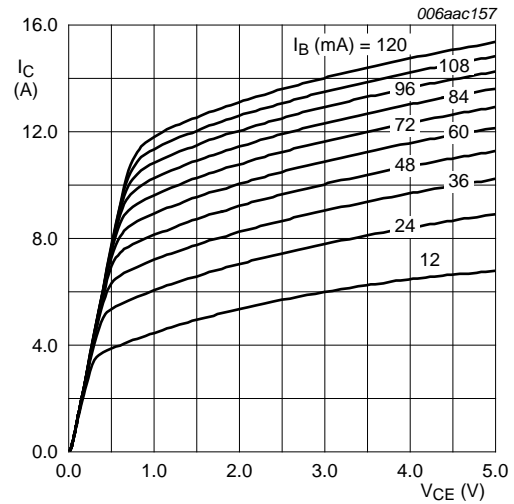
Table 7. Characteristics ...continued

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------|---|---|-----|------|------|------------|
| V_{CEsat} | collector-emitter saturation voltage | $I_C = 1\text{ A}; I_B = 50\text{ mA};$ pulsed; $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02; T_{amb} = 25\text{ }^\circ\text{C}$ | - | 25 | 35 | mV |
| | | $I_C = 1\text{ A}; I_B = 10\text{ mA};$ pulsed; $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02; T_{amb} = 25\text{ }^\circ\text{C}$ | - | 43 | 60 | mV |
| | | $I_C = 2\text{ A}; I_B = 40\text{ mA};$ pulsed; $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02; T_{amb} = 25\text{ }^\circ\text{C}$ | - | 53 | 75 | mV |
| | | $I_C = 4\text{ A}; I_B = 200\text{ mA};$ pulsed; $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02; T_{amb} = 25\text{ }^\circ\text{C}$ | - | 78 | 110 | mV |
| | | $I_C = 4\text{ A}; I_B = 40\text{ mA};$ pulsed; $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02; T_{amb} = 25\text{ }^\circ\text{C}$ | - | 115 | 160 | mV |
| | | $I_C = 7\text{ A}; I_B = 350\text{ mA};$ pulsed; $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02; T_{amb} = 25\text{ }^\circ\text{C}$ | - | 130 | 195 | mV |
| R_{CEsat} | collector-emitter saturation resistance | $I_C = 6\text{ A}; I_B = 600\text{ mA};$ pulsed; $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02; T_{amb} = 25\text{ }^\circ\text{C}$ | - | 17.5 | 25 | m Ω |
| V_{BEsat} | base-emitter saturation voltage | $I_C = 1\text{ A}; I_B = 100\text{ mA};$ pulsed; $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02; T_{amb} = 25\text{ }^\circ\text{C}$ | - | 0.83 | 0.9 | V |
| | | $I_C = 4\text{ A}; I_B = 400\text{ mA};$ pulsed; $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02; T_{amb} = 25\text{ }^\circ\text{C}$ | - | 0.98 | 1.05 | V |
| V_{BEon} | base-emitter turn-on voltage | $V_{CE} = 2\text{ V}; I_C = 2\text{ A};$ pulsed; $t_p \leq 300\text{ }\mu\text{s};$ $\delta \leq 0.02; T_{amb} = 25\text{ }^\circ\text{C}$ | - | 0.72 | 0.85 | V |
| t_d | delay time | $V_{CC} = 12.5\text{ V}; I_C = 1\text{ A}; I_{Bon} = 0.05\text{ A};$ $I_{Boff} = -0.05\text{ A}; T_{amb} = 25\text{ }^\circ\text{C}$ | - | 55 | - | ns |
| t_r | rise time | | - | 55 | - | ns |
| t_{on} | turn-on time | | - | 110 | - | ns |
| t_s | storage time | | - | 1220 | - | ns |
| t_f | fall time | | - | 230 | - | ns |
| t_{off} | turn-off time | | - | 1450 | - | ns |
| f_T | transition frequency | $V_{CE} = 10\text{ V}; I_C = 100\text{ mA}; f = 100\text{ MHz};$ $T_{amb} = 25\text{ }^\circ\text{C}$ | - | 105 | - | MHz |
| C_c | collector capacitance | $V_{CB} = 10\text{ V}; I_E = 0\text{ A}; i_e = 0\text{ A};$ $f = 1\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ | - | 50 | - | pF |



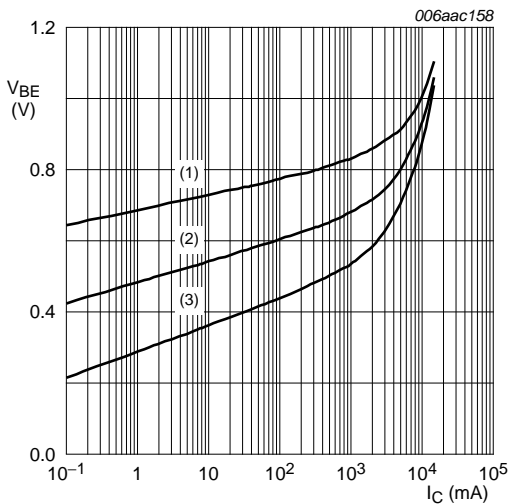
$V_{CE} = 2\text{ V}$
 (1) $T_{amb} = 100\text{ }^{\circ}\text{C}$
 (2) $T_{amb} = 25\text{ }^{\circ}\text{C}$
 (3) $T_{amb} = -55\text{ }^{\circ}\text{C}$

Fig 5. DC current gain as a function of collector current; typical values



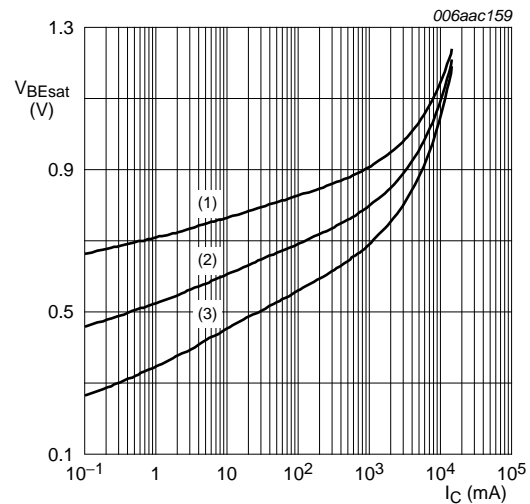
$T_{amb} = 25\text{ }^{\circ}\text{C}$

Fig 6. Collector current as a function of collector-emitter voltage; typical values



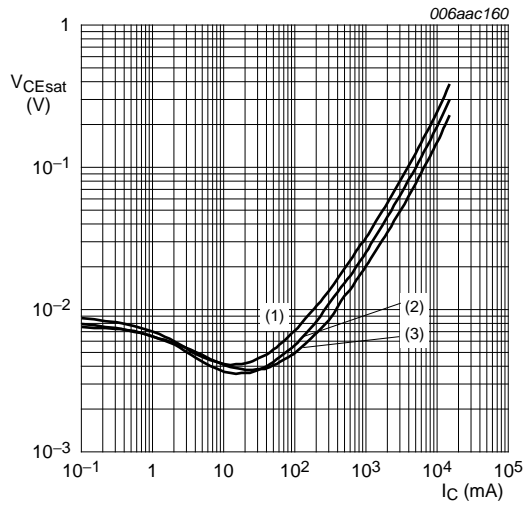
$V_{CE} = 2\text{ V}$
 (1) $T_{amb} = -55\text{ }^{\circ}\text{C}$
 (2) $T_{amb} = 25\text{ }^{\circ}\text{C}$
 (3) $T_{amb} = 100\text{ }^{\circ}\text{C}$

Fig 7. Base-emitter voltage as a function of collector current; typical values



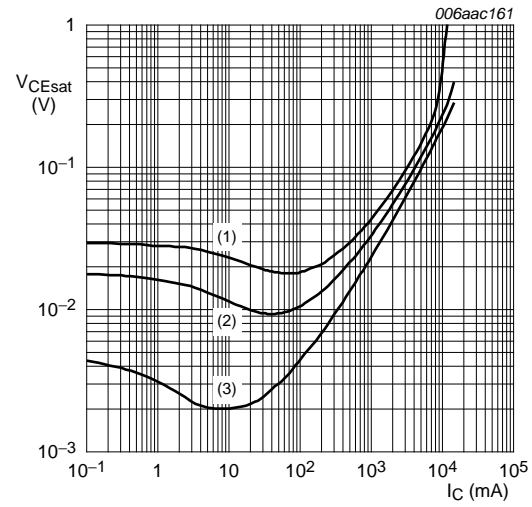
$I_C/I_B = 20$
 (1) $T_{amb} = -55\text{ }^{\circ}\text{C}$
 (2) $T_{amb} = 25\text{ }^{\circ}\text{C}$
 (3) $T_{amb} = 100\text{ }^{\circ}\text{C}$

Fig 8. Base-emitter saturation voltage as a function of collector current; typical values



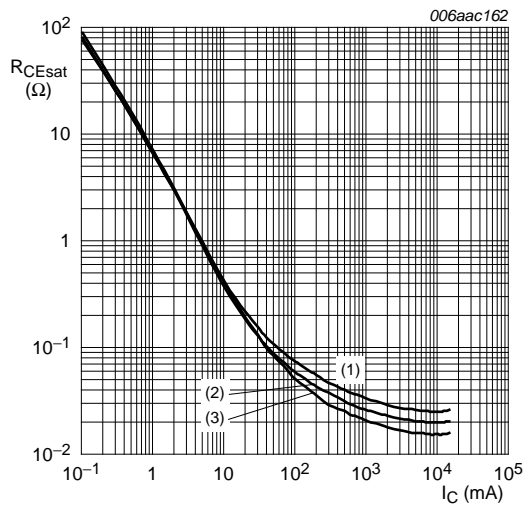
$I_C/I_B = 20$
 (1) $T_{amb} = 100\text{ }^\circ\text{C}$
 (2) $T_{amb} = 25\text{ }^\circ\text{C}$
 (3) $T_{amb} = -55\text{ }^\circ\text{C}$

Fig 9. Collector-emitter saturation voltage as a function of collector current; typical values



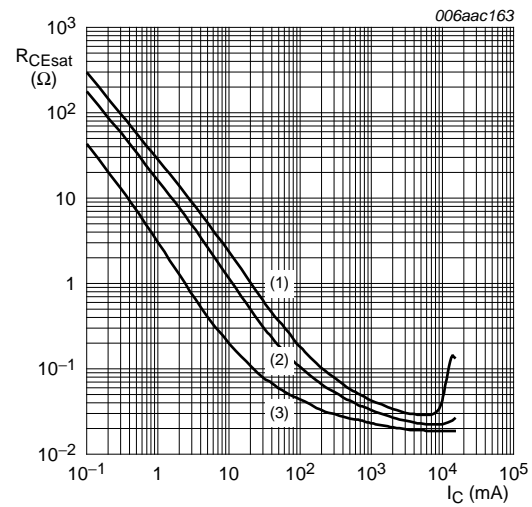
$T_{amb} = 25\text{ }^\circ\text{C}$
 (1) $I_C/I_B = 100$
 (2) $I_C/I_B = 50$
 (3) $I_C/I_B = 10$

Fig 10. Collector-emitter saturation voltage as a function of collector current; typical values



$I_C/I_B = 20$
 (1) $T_{amb} = 100\text{ }^\circ\text{C}$
 (2) $T_{amb} = 25\text{ }^\circ\text{C}$
 (3) $T_{amb} = -55\text{ }^\circ\text{C}$

Fig 11. Collector-emitter saturation resistance as a function of collector current; typical values



$T_{amb} = 25\text{ }^\circ\text{C}$
 (1) $I_C/I_B = 100$
 (2) $I_C/I_B = 50$
 (3) $I_C/I_B = 10$

Fig 12. Collector-emitter saturation resistance as a function of collector current; typical values

8. Test information

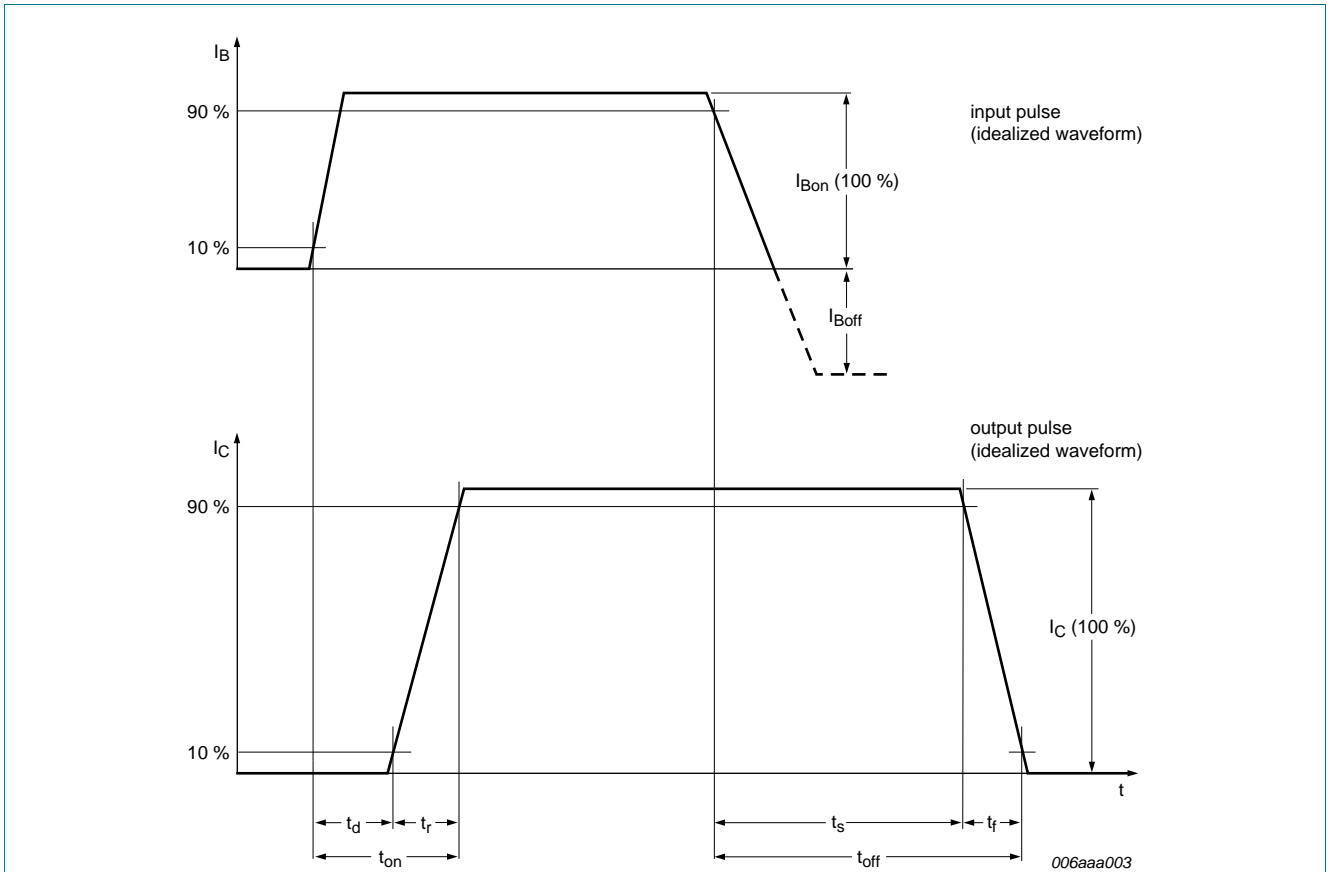


Fig 13. BISS transistor switching time definition

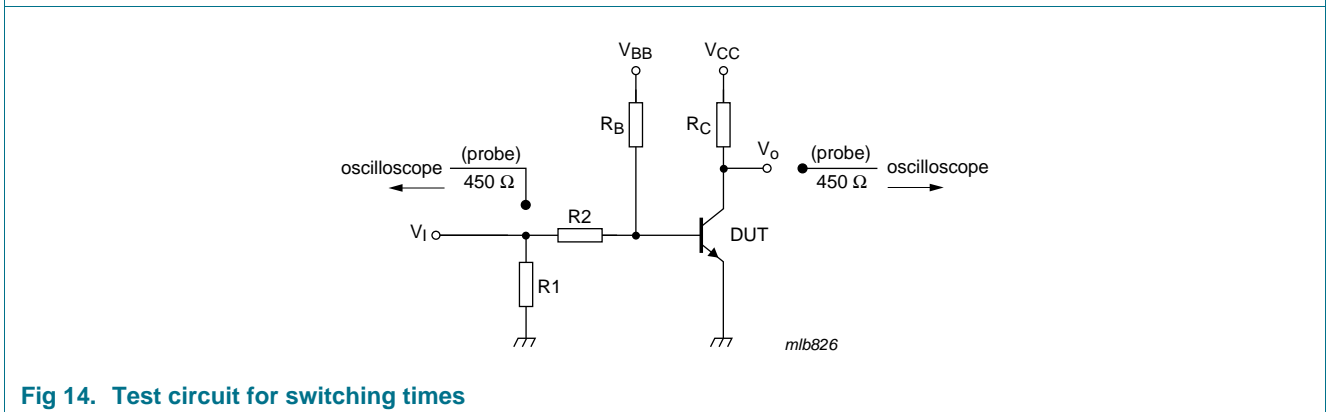


Fig 14. Test circuit for switching times

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline

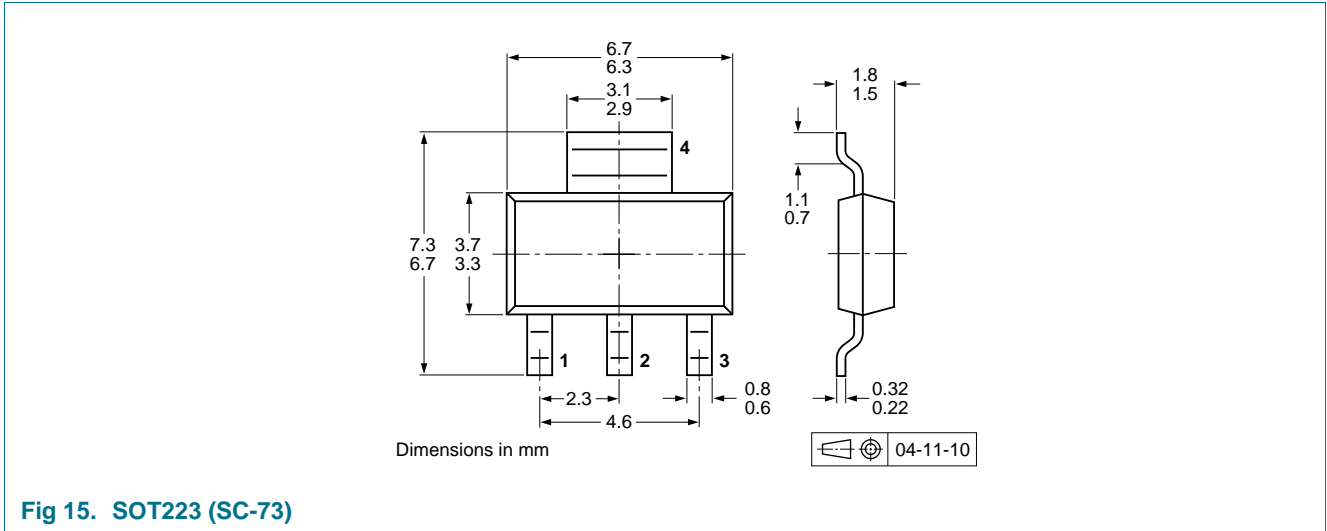


Fig 15. SOT223 (SC-73)

10. Soldering

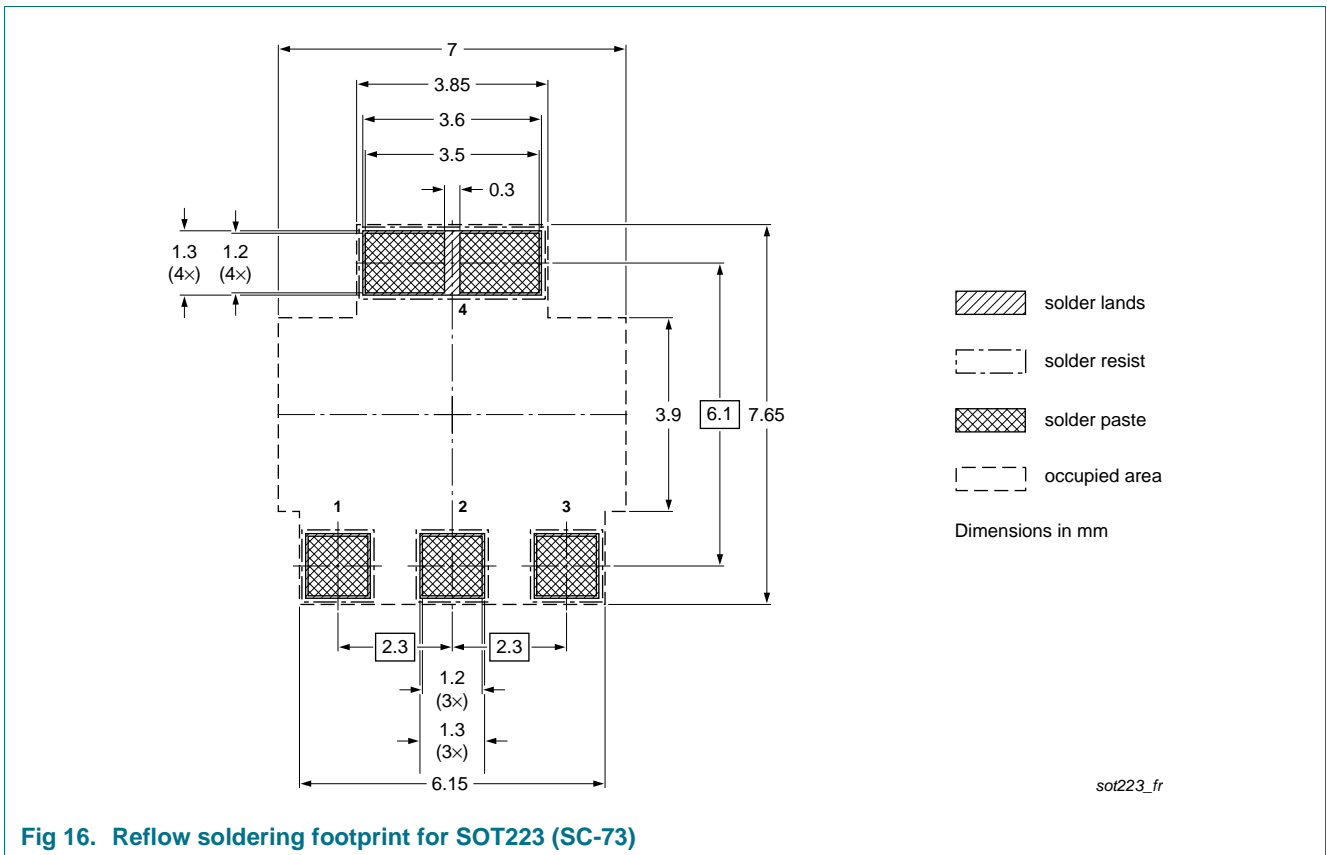


Fig 16. Reflow soldering footprint for SOT223 (SC-73)

11. Revision history

Table 8. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|--|--------------------|---------------|----------------|
| PBSS4041NZ v.2 | 20120808 | Product data sheet | - | PBSS4041NZ v.1 |
| Modifications: | <ul style="list-style-type: none">• 7 "Characteristics": V_{CEsat} corrected• 12 "Legal information": updated | | | |
| PBSS4041NZ v.1 | 20100331 | Product data sheet | - | - |

12. Legal information

12.1 Data sheet status

| Document status ^[1] [2] | Product status ^[3] | Definition |
|------------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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13. Contact information

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For sales office addresses, please send an email to: salesaddresses@nexperia.com

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